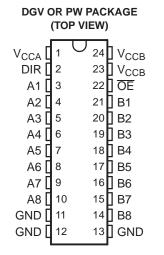
www.ti.com

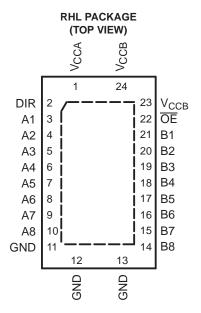
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FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, All I/O Ports Are in the High-Impedance State
- I_{off} Supports Partial Power-Down-Mode Operation
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.4-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant



- Max Data Rates
 - 170 Mbps (V_{CCA} < 1.8 V or V_{CCB} < 1.8 V)
 - 320 Mbps ($V_{CCA} \ge 1.8 \text{ V}$ and $V_{CCB} \ge 1.8 \text{ V}$)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



DESCRIPTION/ORDERING INFORMATION

This 8-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVC8T245 is optimized to operate with V_{CCA}/V_{CCB} set at 1.4 V to 3.6 V. It is operational with V_{CCA}/V_{CCB} as low as 1.2 V. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

ORDERING INFORMATION

| T _A | PACK | AGE ⁽¹⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|----------------|-------------|--------------------|-----------------------|------------------|--|
| | QFN – RHL | Reel of 1000 | SN74AVC8T245RHLR | WE245 | |
| 400C to 950C | TSSOP – PW | Tube of 60 | SN74AVC8T245PW | WE245 | |
| –40°C to 85°C | 1330P – PW | Reel of 2000 | SN74AVC8T245PWR | VVE240 | |
| | TVSOP - DGV | Reel of 2000 | SN74AVC8T245DGVR | WE245 | |

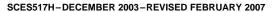
(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

8-BIT DUAL-SUPPLY BUS TRANSCEIVER

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS





DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The SN74AVC8T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVC8T245 is designed so the control pins (DIR and \overline{OE}) are supplied by V_{CCA}.

The SN74AVC8T245 solution is compatible with a single-supply system and can be replaced later with a '245 function, with minimal printed circuit board redesign.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

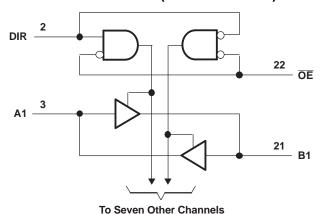
The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} shall be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE (each 8-bit section)

| INP | UTS | OPERATION | | | | | |
|-----|-----|------------------|--|--|--|--|--|
| ŌĒ | DIR | OPERATION | | | | | |
| L | L | B data to A bus | | | | | |
| L | Н | A data to B bus | | | | | |
| Н | Χ | All outputs Hi-Z | | | | | |

LOGIC DIAGRAM (POSITIVE LOGIC)



SN74AVC8T245 8-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|--------------------------------------|---------------------------------------------------------------------------|--------------------|---------------------|----------------------|------|
| V _{CCA} V _{CCB} | Supply voltage range | | -0.5 | 4.6 | V |
| | | I/O ports (A port) | -0.5 | 4.6 | |
| V_{I} | Input voltage range ⁽²⁾ | I/O ports (B port) | -0.5 | 4.6 | V |
| | | Control inputs | -0.5 | 4.6 | |
| \/ | Voltage range applied to any output | A port | -0.5 | 4.6 | V |
| Vo | in the high-impedance or power-off state (2) | B port | -0.5 | 4.6 | V |
| V | Vallana and an all and the annual track to the high and law at the (2)(3) | A port | -0.5 V ₀ | _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state (2)(3) | B port | -0.5 V ₀ | _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| Io | Continuous output current | , | | ±50 | mA |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA |
| | | DGV package | | 86 | |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | PW package | | 88 | °C/W |
| | | RHL package | 43 | | |
| T _{stg} | Storage temperature range | • | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.

SN74AVC8T245

8-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS



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Recommended Operating Conditions (1)(2)(3)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|----------------------------|---------------------------------------|------------------|------------------|-----------------------|-----------------------|------|
| V_{CCA} | Supply voltage | | | | 1.2 | 3.6 | V |
| V _{CCB} | Supply voltage | | | | 1.2 | 3.6 | V |
| | | | 1.2 V to 1.95 V | | $V_{CCI} \times 0.65$ | | |
| V_{IH} | High-level input voltage | Data inputs | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCI} \times 0.35$ | |
| V_{IL} | Low-level input voltage | Data inputs | 1.95 V to 2.7 V | | | 0.7 | V |
| | input voltago | | 2.7 V to 3.6 V | | | 8.0 | |
| | | | 1.2 V to 1.95 V | | $V_{CCA} \times 0.65$ | | |
| V_{IH} | High-level input voltage | DIR (referenced to V _{CCA}) | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltago | (Totolonood to VCCA) | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCA} \times 0.35$ | |
| V_{IL} | Low-level input voltage | DIR (referenced to V _{CCA}) | 1.95 V to 2.7 V | | | 0.7 | V |
| | input voltage | (referenced to vCCA) | 2.7 V to 3.6 V | | | 8.0 | |
| VI | Input voltage | | | | 0 | 3.6 | V |
| V | Output voltage | Active state | | | 0 | V _{cco} | V |
| V_{O} | Output voltage | 3-state | | | 0 | 3.6 | V |
| | | | | 1.2 V | | -3 | |
| | | | | 1.4 V to 1.6 V | | -6 | |
| I_{OH} | High-level output cu | rrent | | 1.65 V to 1.95 V | | -8 | mA |
| | | | | 2.3 V to 2.7 V | | - 9 | |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.2 V | | 3 | |
| | | | | 1.4 V to 1.6 V | | 6 | |
| I_{OL} | Low-level output cur | rrent | | 1.65 V to 1.95 V | | 8 | mA |
| | | | | 2.3 V to 2.7 V | | 9 | |
| | | | | 3 V to 3.6 V | | 12 | |
| Δt/Δν | Input transition rise | or fall rate | | | | 5 | ns/V |
| T _A | Operating free-air te | emperature | | | -40 | 85 | °C |

V_{CCI} is the V_{CC} associated with the input port.
 V_{CCO} is the V_{CC} associated with the output port.
 All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

| DAD | A | TEST CONDIT | IONC | v | v | T, | _A = 25°C | ; | –40°C to 8 | 5°C | UNIT |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|-------------------------------------------------------------------------------|---------------------------------------|------------------|------------------|-----|---------------------|-------|------------------------|------|------|
| PARA | AMETER | TEST CONDIT | IONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | MAX | UNIT |
| | | $I_{OH} = -100 \mu A$ | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | V _{CCO} - 0.2 | | |
| | | $I_{OH} = -3 \text{ mA}$ | | 1.2 V | 1.2 V | | 0.95 | | | | |
| ., | | I _{OH} = -6 mA | ,, ,, | 1.4 V | 1.4 V | | | | 1.05 | | \ / |
| V_{OH} | | $I_{OH} = -8 \text{ mA}$ | $V_I = V_{IH}$ | 1.65 V | 1.65 V | | | | 1.2 | | V |
| | | $I_{OH} = -9 \text{ mA}$ | | 2.3 V | 2.3 V | | | | 1.75 | | |
| | | $I_{OH} = -12 \text{ mA}$ | | 3 V | 3 V | | | | 2.3 | | |
| | | $I_{OL} = 100 \mu A$ | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 0.2 | |
| | | I _{OL} = 3 mA | | 1.2 V | 1.2 V | | 0.15 | | | | |
| ., | | I _{OL} = 6 mA | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | 1.4 V | 1.4 V | | | | | 0.35 | V |
| V_{OL} | | I _{OL} = 8 mA | $V_I = V_{IL}$ | 1.65 V | 1.65 V | | | | | 0.45 | V |
| | | I _{OL} = 9 mA | | 2.3 V | 2.3 V | | | | | 0.55 | |
| | | I _{OL} = 12 mA | | 3 V | 3 V | | | | | 0.7 | |
| l _l | Control inputs | V _I = V _{CCA} or GND | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | ±0.025 | ±0.25 | | ±1 | μΑ |
| | A or B | VV 04-00 | | 0 V | 0 V to 3.6 V | | ±0.1 | ±1 | | ±5 | |
| l _{off} | port | V_I or $V_O = 0$ to 3.6 | V | 0 V to 3.6 V | 0 V | | ±0.1 | ±1 | | ±5 | μΑ |
| I _{OZ} (3) | A or B port | $V_O = V_{CCO}$ or GND $V_I = V_{CCI}$ or GND, $\overline{OE} = V_{IH}$ | , | 3.6 V | 3.6 V | | ±0.5 | ±2.5 | | ±5 | μА |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 15 | |
| I_{CCA} | | $V_I = V_{CCI}$ or GND, | $I_O = 0$ | 0 V | 3.6 V | | | | | -2 | μΑ |
| | | | | 3.6 V | 0 V | | | | | 15 | |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 15 | |
| I_{CCB} | | $V_I = V_{CCI}$ or GND, | $I_O = 0$ | 0 V | 3.6 V | | | | | 15 | μΑ |
| | | | | 3.6 V | 0 V | | | | | -2 | |
| CA> + I <sub< td=""><td>script>C Subscript script>C Subscript</td><td>$V_I = V_{CCI}$ or GND,</td><td>I_O = 0</td><td>1.2 V to 3.6 V</td><td>1.2 V to 3.6 V</td><td></td><td></td><td></td><td></td><td>25</td><td>μΑ</td></sub<> | script>C Subscript script>C Subscript | $V_I = V_{CCI}$ or GND, | I _O = 0 | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 25 | μΑ |
| C _i | Control inputs | V _I = 3.3 V or GND | | 3.3 V | 3.3 V | | 3.5 | | | 4.5 | pF |
| C _{io} | A or B port | V _O = 3.3 V or GND | ı | 3.3 V | 3.3 V | | 6 | | | 7 | pF |

 ⁽¹⁾ V_{CCO} is the V_{CC} associated with the output port.
 (2) V_{CCI} is the V_{CC} associated with the input port.
 (3) For I/O ports, the parameter I_{OZ} includes the input leakage current.

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Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 10)

| PARAMETER | FROM | то | V _{CCB} = 1.2 V | V _{CCB} = 1.5 V | V _{CCB} = 1.8 V | V _{CCB} = 2.5 V | V _{CCB} = 3.3 V | UNIT | | | | | | | | | |
|------------------|---------|----------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|------|-----|----|----|---|-----|---|-----|-----|-----|
| PARAMETER | (INPUT) | (OUTPUT) | TYP | TYP | TYP | TYP | TYP | UNII | | | | | | | | | |
| t _{PLH} | А | В | 3.1 | 2.6 | 2.5 | 3 | 3.5 | 20 | | | | | | | | | |
| t _{PHL} | A | Ь | 3.1 | 2.6 | 2.5 | 3 | 3.5 | ns | | | | | | | | | |
| t _{PLH} | В | Α | 3.1 | 2.7 | 2.5 | 2.4 | 2.3 | ns | | | | | | | | | |
| t _{PHL} | Б | A | 3.1 | 2.7 | 2.5 | 2.4 | 2.3 | 115 | | | | | | | | | |
| t _{PZH} | ŌĒ | ŌĒ | ŌĒ | Α | 5.3 | 5.3 | 5.3 | 5.3 | 5.3 | no | | | | | | | |
| t _{PZL} | OE | A | 5.3 | 5.3 | 5.3 | 5.3 | 5.3 | ns | | | | | | | | | |
| t _{PZH} | ŌĒ | В | 5.1 | 4 | 3.5 | 3.2 | 3.1 | ns | | | | | | | | | |
| t _{PZL} | OL | В | 5.1 | 4 | 3.5 | 3.2 | 3.1 | 115 | | | | | | | | | |
| t _{PHZ} | ŌĒ | ^ | 4.8 | 4.8 | 4.8 | 4.8 | 4.8 | ns | | | | | | | | | |
| t _{PLZ} | OL | A | 4.8 | 4.8 | 4.8 | 4.8 | 4.8 | 115 | | | | | | | | | |
| t _{PHZ} | ŌĒ | В | 4.7 | 4 | 4.1 | 4.3 | 5.1 | nc | | | | | | | | | |
| t _{PLZ} | | OE | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 4.7 | 4 | 4.1 | 4.3 | 5.1 |

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 10)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | 1.5 V I V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0. | = 3.3 V 3 V | UNIT | | | | | | | | | | | | |
|------------------|-----------------|-----------------|--------------------------|--------------------------|--------------|-----------------------------|-----|--------------------------|-----|-------------------------|----------------|------|----|---|-----|-----|-----|-----|-----|-----|-----|-----|-----|----|
| | (INFOT) | (0011 01) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | | | | | |
| t _{PLH} | А | В | 2.7 | 0.5 | 5.4 | 0.5 | 4.6 | 0.5 | 4.9 | 0.5 | 6.8 | 20 | | | | | | | | | | | | |
| t _{PHL} | Α | Б | 2.7 | 0.5 | 5.4 | 0.5 | 4.6 | 0.5 | 4.9 | 0.5 | 6.8 | ns | | | | | | | | | | | | |
| t _{PLH} | В | ^ | 2.6 | 0.5 | 5.4 | 0.5 | 5.1 | 0.5 | 4.7 | 0.5 | 4.5 | 20 | | | | | | | | | | | | |
| t _{PHL} | В | A | 2.6 | 0.5 | 5.4 | 0.5 | 5.1 | 0.5 | 4.7 | 0.5 | 4.5 | ns | | | | | | | | | | | | |
| t _{PZH} | ŌĒ | ^ | 3.7 | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | | | | | | | | | | | | | |
| t _{PZL} | OE | Α | 3.7 | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | ns | | | | | | | | | | | | |
| t _{PZH} | OF. | В | 4.8 | 1.1 | 7.6 | 1.1 | 7.1 | 1 | 5.6 | 1 | 5.2 | 20 | | | | | | | | | | | | |
| t _{PZL} | OE | OE B | 4.8 | 1.1 | 7.6 | 1.1 | 7.1 | 1 | 5.6 | 1 | 5.2 | ns | | | | | | | | | | | | |
| t _{PHZ} | OF. | ^ | 3.1 | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | 20 | | | | | | | | | | | | |
| t _{PLZ} | ŌĒ | A | 3.1 | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | ns | | | | | | | | | | | | |
| t _{PHZ} | <u> </u> | В | 4.1 | 0.5 | 8.4 | 0.5 | 7.6 | 0.5 | 7.2 | 0.5 | 7.8 | 20 | | | | | | | | | | | | |
| t _{PLZ} | ŌĒ | ŌĒ | OE | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 4.1 | 0.5 | 8.4 | 0.5 | 7.6 | 0.5 | 7.2 | 0.5 | 7.8 | ns |



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 10)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | : 1.8 V I5 V | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | | | | | | | | | | | | |
|------------------|-----------------|----------------|--------------------------|--------------------------|-----|--------------------------|-----------------|--------------------------|-----|--------------------------|-----|------|-----|----|-----|-----|-----|-----|-----|-----|---|-----|-----|----|
| | | | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | | | | | |
| t _{PLH} | А | В | 2.5 | 0.5 | 5.1 | 0.5 | 4.4 | 0.5 | 4 | 0.5 | 3.9 | no | | | | | | | | | | | | |
| t _{PHL} | A | Б | 2.5 | 0.5 | 5.1 | 0.5 | 4.4 | 0.5 | 4 | 0.5 | 3.9 | ns | | | | | | | | | | | | |
| t _{PLH} | В | ۸ | 2.5 | 0.5 | 4.6 | 0.5 | 4.4 | 0.5 | 3.9 | 0.5 | 3.7 | ns | | | | | | | | | | | | |
| t _{PHL} | ь | Α | 2.5 | 0.5 | 4.6 | 0.5 | 4.4 | 0.5 | 3.9 | 0.5 | 3.7 | 115 | | | | | | | | | | | | |
| t _{PZH} | ŌĒ | Α | 3 | 1 | 6.8 | 1 | 6.8 | 1 | 6.8 | 1 | 6.8 | no | | | | | | | | | | | | |
| t _{PZL} | OE | A | 3 | 1 | 6.8 | 1 | 6.8 | 1 | 6.8 | 1 | 6.8 | ns | | | | | | | | | | | | |
| t _{PZH} | ŌĒ | В | 4.6 | 1.1 | 8.2 | 1 | 6.7 | 0.5 | 5.1 | 0.5 | 4.5 | no | | | | | | | | | | | | |
| t _{PZL} | OE | Б | 4.6 | 1.1 | 8.2 | 1 | 6.7 | 0.5 | 5.1 | 0.5 | 4.5 | ns | | | | | | | | | | | | |
| t _{PHZ} | ŌĒ | <u> </u> | OF. | ۸ | 2.8 | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | ns | | | | | | | | | | |
| t _{PLZ} | | A | 2.8 | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | 115 | | | | | | | | | | | | |
| t _{PHZ} | <u> </u> | В | 3.9 | 0.5 | 7.8 | 0.5 | 6.9 | 0.5 | 6 | 0.5 | 5.8 | no | | | | | | | | | | | | |
| t _{PLZ} | ΟĒ | ŌĒ | OE | OE | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | D | 3.9 | 0.5 | 7.8 | 0.5 | 6.9 | 0.5 | 6 | 0.5 | 5.8 | ns |

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 10)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | 1.5 V I V | V _{CCB} = 1.8 V ± 0.15 V | | 1.8 V $V_{CCB} = 2.5 V$ 5 V $\pm 0.2 V$ | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT | | | | | |
|------------------|-----------------|----------------|--------------------------|-----------------------------|--------------|--------------------------------------|-----|--------------------------------------------|-----|-------------------------------------|-----|------|-----|-----|-----|-----|-----|
| | (INFOT) | (001701) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | |
| t _{PLH} | ٨ | В | 2.4 | 0.5 | 4.7 | 0.5 | 3.9 | 0.5 | 3.1 | 0.5 | 2.8 | | | | | | |
| t _{PHL} | Α | В | 2.4 | 0.5 | 4.7 | 0.5 | 3.9 | 0.5 | 3.1 | 0.5 | 2.8 | ns | | | | | |
| t _{PLH} | В | А | 3 | 0.5 | 4.9 | 0.5 | 4 | 0.5 | 3.1 | 0.5 | 2.9 | | | | | | |
| t _{PHL} | В | A | 3 | 0.5 | 4.9 | 0.5 | 4 | 0.5 | 3.1 | 0.5 | 2.9 | ns | | | | | |
| t _{PZH} | | OE. | ŌĒ | ^ | 2.2 | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | | | | |
| t_{PZL} | OE | A | 2.2 | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | ns | | | | | |
| t _{PZH} | ŌĒ | В | 4.5 | 1.1 | 7.9 | 0.5 | 6.4 | 0.5 | 4.6 | 0.5 | 4 | | | | | | |
| t _{PZL} | OE | В | 4.5 | 1.1 | 7.9 | 0.5 | 6.4 | 0.5 | 4.6 | 0.5 | 4 | ns | | | | | |
| t _{PHZ} | ŌĒ | o. | 0 - | ^ | 1.8 | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | | | | |
| t _{PLZ} | | A | 1.8 | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | ns | | | | | |
| t _{PHZ} | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 3.6 | 0.5 | 7.1 | 0.5 | 6.3 | 0.5 | 5.1 | 0.5 | 3.9 | |
| t _{PLZ} | | | | | | | ŌĒ | ŌĒ | ŌĒ | ŌĒ | В | 3.6 | 0.5 | 7.1 | 0.5 | 6.3 | 0.5 |

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS



SCES517H-DECEMBER 2003-REVISED FEBRUARY 2007

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (see Figure 10)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT | | | | | | | | | | | | | |
|------------------|-----------------|----------------|--------------------------|-----------------------------|-----|--------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|------|----|----|---|-----|-----|-----|-----|---|-----|-----|-----|-----|----|
| | (INFUI) | (0011 01) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | | | | | | | | | | | |
| t _{PLH} | Α | В | 2.3 | 0.5 | 4.5 | 0.5 | 3.7 | 0.5 | 2.9 | 0.5 | 2.5 | 20 | | | | | | | | | | | | | |
| t _{PHL} | A | ь | 2.3 | 0.5 | 4.5 | 0.5 | 3.3 | 0.5 | 2.9 | 0.5 | 2.5 | ns | | | | | | | | | | | | | |
| t _{PLH} | В | Α | 3.5 | 0.5 | 6.8 | 0.5 | 3.9 | 0.5 | 2.8 | 0.5 | 2.5 | ns | | | | | | | | | | | | | |
| t _{PHL} | | A | 3.5 | 0.5 | 6.8 | 0.5 | 3.9 | 0.5 | 2.8 | 0.5 | 2.5 | 10 | | | | | | | | | | | | | |
| t _{PZH} | OE. | ŌĒ | ^ | 2 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | no | | | | | | | | | | | | |
| t _{PZL} | OE | A | 2 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | ns | | | | | | | | | | | | | |
| t _{PZH} | ŌĒ | В | 4.5 | 1.1 | 7.8 | 0.5 | 6.2 | 0.5 | 4.5 | 0.5 | 3.9 | ns | | | | | | | | | | | | | |
| t _{PZL} | OE | Ь | 4.5 | 1.1 | 7.8 | 0.5 | 6.2 | 0.5 | 4.5 | 0.5 | 3.9 | 115 | | | | | | | | | | | | | |
| t _{PHZ} | ∩E | ^ | 1.7 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | ns | | | | | | | | | | | | | |
| t _{PLZ} | OE | ŌĒ A | 1.7 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | 0.5 | 4 | 115 | | | | | | | | | | | | | |
| t _{PHZ} | <u> </u> | В | 3.4 | 0.5 | 6.9 | 0.5 | 6 | 0.5 | 4.8 | 0.5 | 4.2 | no | | | | | | | | | | | | | |
| t _{PLZ} | OE | OE | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | ŌĒ | D | 3.4 | 0.5 | 6.9 | 0.5 | 6 | 0.5 | 4.8 | 0.5 | 4.2 | ns |

Operating Characteristics

 $T_A = 25^{\circ}C$

| F | PARAME | TER | TEST CONDITIONS | V _{CCA} = V _{CCB} = 1.2 V | V _{CCA} = V _{CCB} = 1.5 V | V _{CCA} = V _{CCB} = 1.8 V | $V_{CCA} = V_{CCB} = 2.5 V$ | $V_{CCA} = V_{CCB} = 3.3 V$ | UNIT |
|----------------------|----------------------------------------|------------------|-------------------------------------------------------------|---------------------------------------------|---------------------------------------------|---------------------------------------------|-----------------------------|-----------------------------|------|
| | A to D | Outputs enabled | | 1 | 1 | 1 | 1 | 1 | |
| C (1) | C _{pdA} ⁽¹⁾ B to A | Outputs disabled | $C_L = 0,$ $f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$ | 1 | 1 | 1 | 1 | 1 | s.E |
| OpdA | | Outputs enabled | | 12 | 12 | 12 | 13 | 14 | pF |
| | B to A | Outputs disabled | | 1 | 1 | 1 | 1 | 1 | |
| | A to D | Outputs enabled | | 12 | 12 | 12 | 13 | 14 | |
| C (1) | A to B - | Outputs disabled | $C_L = 0,$ | 1 | 1 | 1 | 1 | 1 | 5 F |
| ∪ _{pdB} (1) | | Outputs enabled | f = 10 MHz, $t_r = t_f = 1 \text{ ns}$ | 1 | 1 | 1 | 1 | 1 | pF |
| | | Outputs disabled | | 1 | 1 | 1 | 1 | 1 | |

⁽¹⁾ Power dissipation capacitance per transceiver

Table 1. Typical Total Static Power Consumption (I_{CCA} + I_{CCB})

| | ,, | | | | I (CCA CCD) | | | | | | |
|------------------|------------------|-------|-------|-------|-------------|-------|------|--|--|--|--|
| V | V _{CCA} | | | | | | | | | | |
| V _{CCB} | 0 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | UNIT | | | | |
| 0 V | 0 | <0.5 | <0.5 | <0.5 | <0.5 | <0.5 | | | | | |
| 1.2 V | <0.5 | <1 | <1 | <1 | <1 | 1 | | | | | |
| 1.5 V | <0.5 | <1 | <1 | <1 | <1 | 1 | | | | | |
| 1.8 V | <0.5 | <1 | <1 | <1 | <1 | <1 | μΑ | | | | |
| 2.5 V | <0.5 | 1 | <1 | <1 | <1 | <1 | | | | | |
| 3.3 V | <0.5 | 1 | <1 | <1 | <1 | <1 | | | | | |



TYPICAL CHARACTERISTICS

Typical Propagation Delay (A to B) vs Load Capacitance T_{A} = 25°C, V_{CCA} = 1.2 V

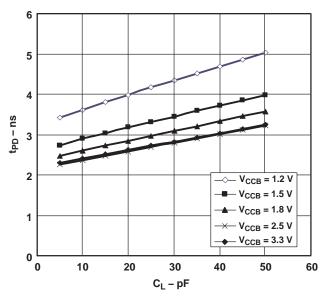
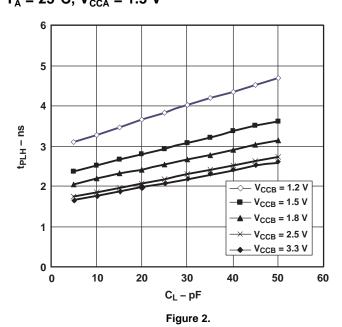
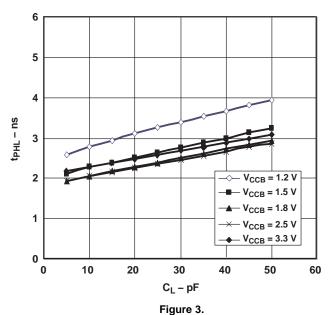


Figure 1.

Typical Propagation Delay (A to B) vs Load Capacitance T_{A} = 25°C, V_{CCA} = 1.5 V

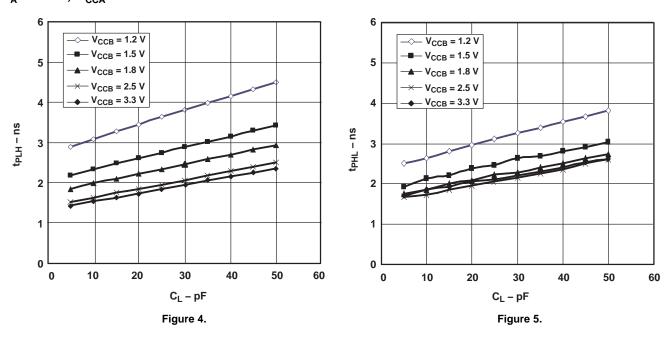




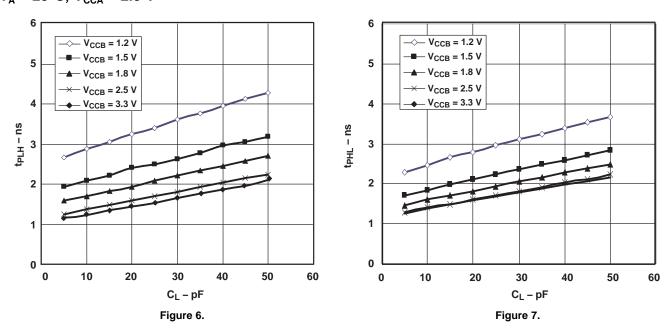


TYPICAL CHARACTERISTICS (continued)

Typical Propagation Delay (A to B) vs Load Capacitance $\rm T_A = 25^{\circ}C,\ V_{CCA} = 1.8\ V$

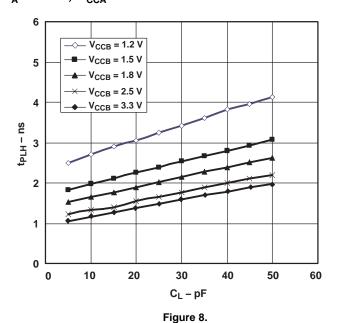


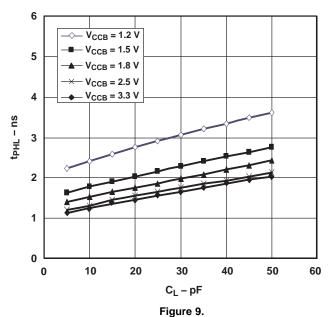
Typical Propagation Delay (A to B) vs Load Capacitance T_{A} = 25°C, V_{CCA} = 2.5 V



TYPICAL CHARACTERISTICS (continued)

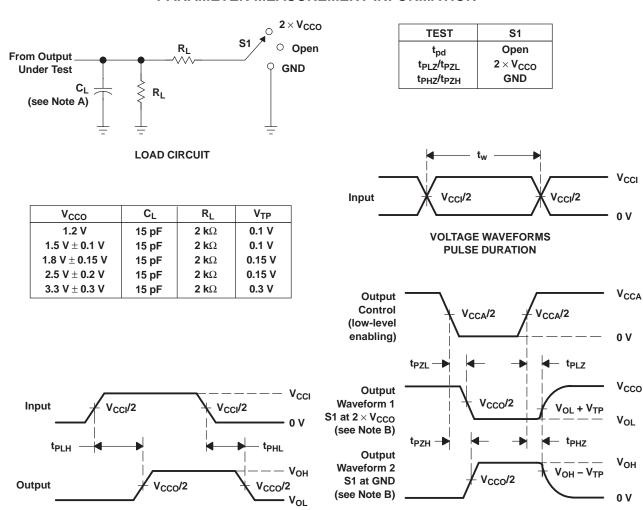
Typical Propagation Delay (A to B) vs Load Capacitance $\rm T_A = 25^{\circ}C,\ V_{CCA} = 3.3\ V$







PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

VOLTAGE WAVEFORMS

ENABLE AND DISABLE TIMES

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$, $dv/dt \geq$ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

VOLTAGE WAVEFORMS

PROPAGATION DELAY TIMES

Figure 10. Load Circuit and Voltage Waveforms







PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Packag Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | n MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|-----------------|--------------------|------|---------------|---------------------------|------------------|--------------------------------|
| 74AVC8T245DGVRE4 | ACTIVE | TVSOP | DGV | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AVC8T245DGVRG4 | ACTIVE | TVSOP | DGV | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AVC8T245RHLRG4 | ACTIVE | QFN | RHL | 24 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| SN74AVC8T245DGVR | ACTIVE | TVSOP | DGV | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245PW | ACTIVE | TSSOP | PW | 24 | 60 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245PWE4 | ACTIVE | TSSOP | PW | 24 | 60 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245PWG4 | ACTIVE | TSSOP | PW | 24 | 60 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245PWR | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245PWRE4 | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245PWRG4 | ACTIVE | TSSOP | PW | 24 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AVC8T245RHLR | ACTIVE | QFN | RHL | 24 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

www.ti.com 19-Nov-2008

to Customer on an annual basis.



TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|-----------------------------------------------------------|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|-------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74AVC8T245DGVR | TVSOP | DGV | 24 | 2000 | 330.0 | 12.4 | 7.0 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74AVC8T245PWR | TSSOP | PW | 24 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| SN74AVC8T245RHLR | QFN | RHL | 24 | 1000 | 180.0 | 12.4 | 3.8 | 5.8 | 1.2 | 8.0 | 12.0 | Q1 |





*All dimensions are nominal

| 7 til diritoriolorio aro nominal | | | | | | | |
|----------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| SN74AVC8T245DGVR | TVSOP | DGV | 24 | 2000 | 346.0 | 346.0 | 29.0 |
| SN74AVC8T245PWR | TSSOP | PW | 24 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74AVC8T245RHLR | QFN | RHL | 24 | 1000 | 190.5 | 212.7 | 31.8 |

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

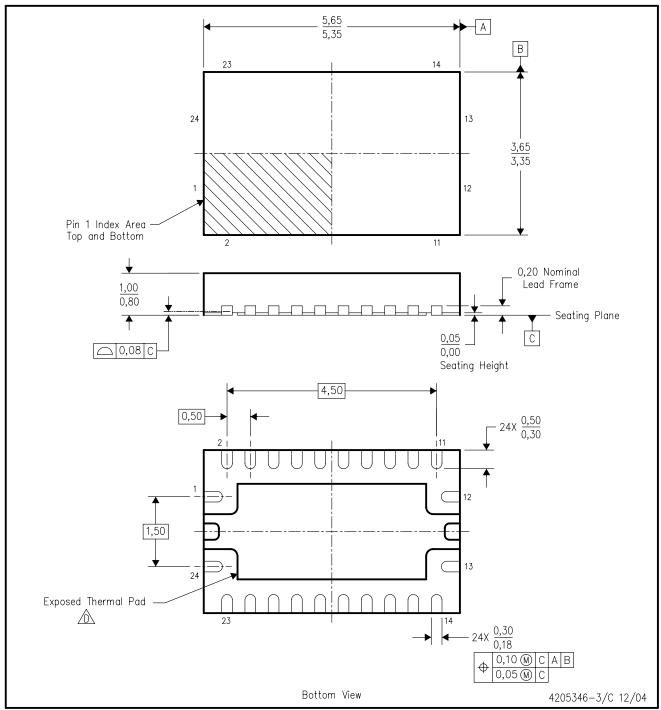
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

RHL (R-PQFP-N24)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
 - E. JEDEC MO-241 package registration pending.



THERMAL PAD MECHANICAL DATA



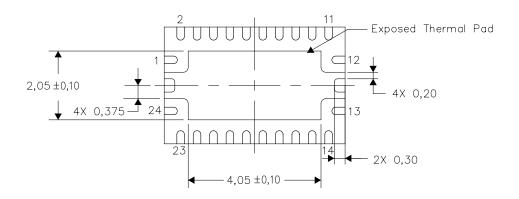
RHL (R-PVQFN-N24)

THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.

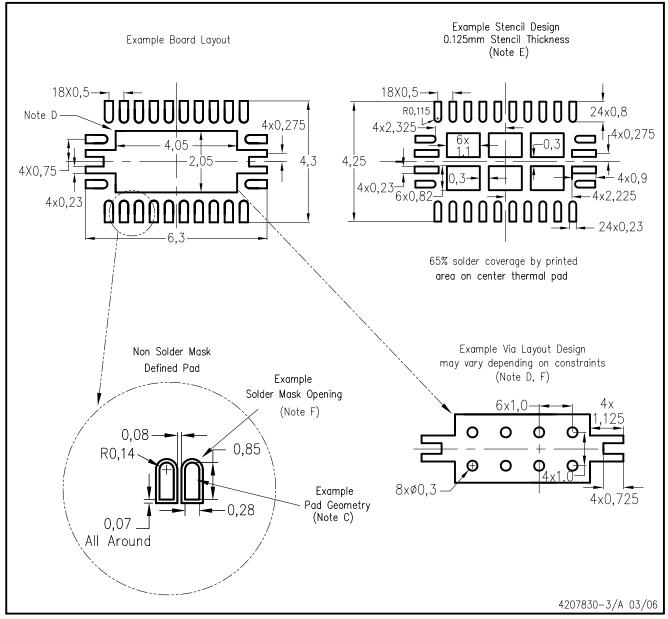


Bottom View

NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions

RHL (R-PQFP-N24)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat—Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com https://www.ti.com.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



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